

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
Stylesheet Version v1.2

EPAS ID: PAT3206095

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
CHWAN-HWA CHIANG	01/27/2015
BAO-SHEN ZHANG	01/27/2015
CHIEH-HSIANG WANG	01/27/2015
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	SHENZHEN FUTAIHONG PRECISION INDUSTRY CO., LTD.
<b>Street Address:</b>	Section F3-A, Foxconn Technology Industry Zone, LongHua Town, BaoAn District
<b>City:</b>	Shenzhen
<b>State/Country:</b>	CHINA
<b>Name:</b>	FIH (HONG KONG) LIMITED
<b>Street Address:</b>	8/F., Peninsula Tower, 538 Castle Peak Road, Cheung Sha Wan
<b>City:</b>	Kowloon
<b>State/Country:</b>	HONG KONG
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	14610154
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(713)456-2836
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	7135713400
<b>Email:</b>	ea-cbd@scienbizip.com, eoa-proce@scienbizip.com, sbp@novakdruce.com
<b>Correspondent Name:</b>	JASON W. BRYAN
<b>Address Line 1:</b>	1000 LOUISIANA STREET, FIFTY-THIRD FLOOR
<b>Address Line 4:</b>	HOUSTON, TEXAS 77002
<b>ATTORNEY DOCKET NUMBER:</b>	US57576
<b>NAME OF SUBMITTER:</b>	JASON W. BRYAN
<b>SIGNATURE:</b>	/Jason W. Bryan/
<b>DATE SIGNED:</b>	01/30/2015

**Total Attachments: 2**

source=US57576150128ASM#page1.tif

source=US57576150128ASM#page2.tif

### ASSIGNMENT

In consideration of value received, the receipt and sufficiency of which are hereby acknowledged, the undersigned ASSIGNOR(S)

- 1. CHWAN-HWA CHIANG , residing at Shindian, New Taipei, Taiwan
- 2. BAO-SHEN ZHANG , residing at Shenzhen, Guangdong, China
- 3. CHIEH-HSIANG WANG , residing at Shindian, New Taipei, Taiwan
- 4. \_\_\_\_\_ , residing at \_\_\_\_\_
- 5. \_\_\_\_\_ , residing at \_\_\_\_\_
- 6. \_\_\_\_\_ , residing at \_\_\_\_\_
- 7. \_\_\_\_\_ , residing at \_\_\_\_\_
- 8. \_\_\_\_\_ , residing at \_\_\_\_\_

hereby sell(s), assign(s) and transfer(s) unto: **SHENZHEN FUTAIHONG PRECISION INDUSTRY CO., LTD.** having a principal place of business at **Section F3-A, Foxconn Technology Industry Zone, LongHua Town, BaoAn District, ShenZhen City, Guangdong Province 518109, P.R.C.** and **FIH (HONG KONG) LIMITED** having a principal place of business at **8/F., Peninsula Tower, 538 Castle Peak Road, Cheung Sha Wan, Kowloon, Hong Kong** hereafter designated "ASSIGNEE" the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100, in the invention and all patent applications including any and all divisions, continuations, substitutes, and reissues thereof, and all resulting patents, known as **METAL-AND-RESIN COMPOSITE AND METHOD FOR MAKING THE SAME** for which the undersigned

[ ] previously executed --- Ser. No. \_\_\_\_\_ and filing date of \_\_\_\_\_  
[ x ] is executing concurrently herewith

an application for Letters Patent of United States of America

AND the undersigned hereby authorize(s) and request(s) the United States Commissioner of Patents and Trademarks to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree(s) that the attorneys of record in said application, if any, shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree(s) to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE's full protection and title in and to the invention hereby transferred.

1.	<u>Chwan-hwa Chiang</u> CHWAN-HWA CHIANG	<u>2015.1.27</u> Date
2.	<u>Bao-shen Zhang</u> BAO-SHEN ZHANG	<u>2015.1.27</u> Date
3.	<u>Chieh-Hsiang Wang</u> CHIEH-HSIANG WANG	<u>2015.1.27</u> Date
4.	_____	_____ Date
5.	_____	_____ Date
6.	_____	_____ Date
7.	_____	_____ Date
8.	_____	_____ Date